



SPECIFICATION

• Supplier : Samsung electro-mechanics • Samsung P/N : CL21X226MQQNNNE

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 22 µF, 6.3V, ±20%, X6S, 0805

A. Samsung Part Number

<u>CL</u> <u>21</u> <u>X</u> <u>226</u> <u>M</u> <u>Q</u> <u>Q</u> <u>N</u> <u>N</u> <u>N</u> <u>E</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor				
2	Size	0805 (inch code)	L: 2.0	± 0.15 mm	W:	1.25 ± 0.15 mm
3	Dielectric	X6S	8	Inner electrode		Ni
4	Capacitance	22 μF		Termination		Cu
(5)	Capacitance	±20 %		Plating		Sn 100% (Pb Free)
	tolerance		9	Product		Normal
6	Rated Voltage	6.3 V	10	Special		Reserved for future use
7	Thickness	1.25 ± 0.15 mm	11)	Packaging		Embossed Type, 7"reel(2,000ea)

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition			
Capacitance	Within specified tolerance	120Hz ±20% 0.5±0.1Vrms			
Tan δ (DF)	0.1 max.				
Insulation	More than 100Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.			
Resistance					
Appearance	No abnormal exterior appearance	Visual inspection			
Withstanding	No dielectric breakdown or	250% of the rated voltage			
Voltage	mechanical breakdown				
Temperature	X6S				
Characteristics	(From -55℃ to 105℃, Capacitance change should be within ±22%)				
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.			
of Termination	terminal electrode				
Bending Strength	Capacitance change: within ±12.5%	Bending to the limit (1mm)			
		with 1.0mm/sec.			
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder			
	is to be soldered newly	245±5℃, 3±0.3sec.			
		(preheating : 80~120 ℃ for 10~30sec.)			
Resistance to	Capacitance change: within ±7.5%	Solder pot : 270±5 ℃, 10±1sec.			
Soldering heat	Tan δ, IR : initial spec.				

	Performance	Test condition			
Vibration Test	Capacitance change: within ±10%	Amplitude : 1.5mm			
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)			
		2hours × 3 direction (x, y, z)			
Moisture	Capacitance change: within ±12.5%	With rated voltage			
Resistance	Tan δ : 0.2 max	40±2℃, 90~95%RH, 500+12/-0 hour			
	IR : More than 12.5MΩ·μF				
High Temperature	Capacitance change: within ±12.5%	With 100% of the rated voltage			
Resistance	Tan δ : 0.2 max	Max. operating temperature			
	IR : More than 25MΩ·μF				
		1000+48/-0 hour			
Temperature	Capacitance change: within ±15%	1 cycle condition			
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C			
		→ Max. operating temperature → 25°C			
		5 cycles test			

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^{\circ}$ C , 10sec. Max)

^{*} For the more detail Specification, Please refer to the Samsung MLCC catalogue.